

# Monolithic Dual Switching Diode Common Cathode

# BAV70DXV6, NSVBAV70DXV6

#### **Features**

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS (EACH DIODE)**

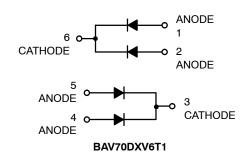
Rating	Symbol	Value	Unit	
Reverse Voltage	$V_R$	100	Vdc	
Forward Current	l <sub>F</sub> 200		mAdc	
Peak Forward Surge Current	I <sub>FM(surge)</sub>	500	mAdc	

### THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation, T <sub>A</sub> = 25°C	P <sub>D</sub>	357 (Note 1)	mW
Derate above 25°C		2.9 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	°C/W
Characteristic			
(Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation, T <sub>A</sub> = 25°C	P <sub>D</sub>	500 (Note 1)	mW
Derate above 25°C		4.0 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	250 (Note 1)	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad





### **MARKING DIAGRAM**



A4 = Specific Device Code

M = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BAV70DXV6T1G	SOT-563 (Pb-Free)	4000 / Tape & Reel
BAV70DXV6T5G	SOT-563 (Pb-Free)	8000 / Tape & Reel
NSVBAV70DXV6T5G	SOT-563 (Pb-Free)	8000 / Tape & Reel

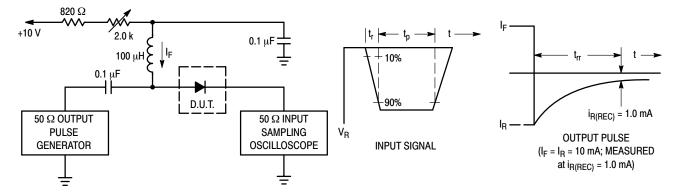
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) (EACH DIODE)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS	•		•		•
Reverse Breakdown Voltage (Note 2) (I <sub>(BR)</sub> = 100 μAdc)		V <sub>(BR)</sub>	100	_	Vdc
Reverse Voltage Leakage Current (Note 2)		I <sub>R</sub>	- - -	60 1.0 100	μAdc
Diode Capacitance (Note 2) (V <sub>R</sub> = 0, f = 1.0 MHz)		C <sub>D</sub>	-	1.5	pF
Forward Voltage (Note 2)  (I <sub>F</sub> = 1.0 mAdc)  (I <sub>F</sub> = 10 mAdc)  (I <sub>F</sub> = 50 mAdc)  (I <sub>F</sub> = 150 mAdc)		V <sub>F</sub>	- - - -	715 855 1000 1250	mVdc
Reverse Recovery Time (Note 2) $(I_F = I_R = 10 \text{ mAdc}, V_R = 5.0 \text{ Vdc}, I_{R(REC)} = 1.0 \text{ mAdc})$ (Figure 1)	R <sub>L</sub> = 100 Ω	t <sub>rr</sub>	-	6.0	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>2.</sup> For each individual diode while second diode is unbiased.



Notes: 1. A 2.0  $k\Omega$  variable resistor adjusted for a Forward Current (IF) of 10 mA.

- 2. Input pulse is adjusted so I<sub>R(peak)</sub> is equal to 10 mA.
- 3. t<sub>p</sub> » t<sub>rr</sub>

Figure 1. Recovery Time Equivalent Test Circuit

# **Curves Applicable to Each Anode**

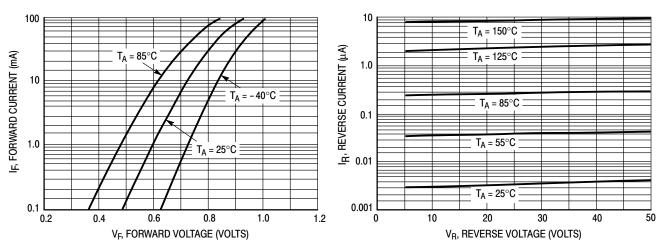


Figure 2. Forward Voltage

Figure 3. Leakage Current

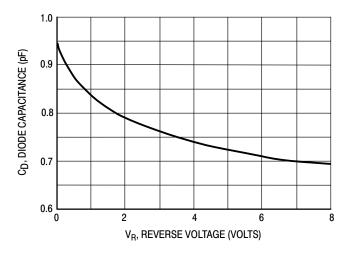


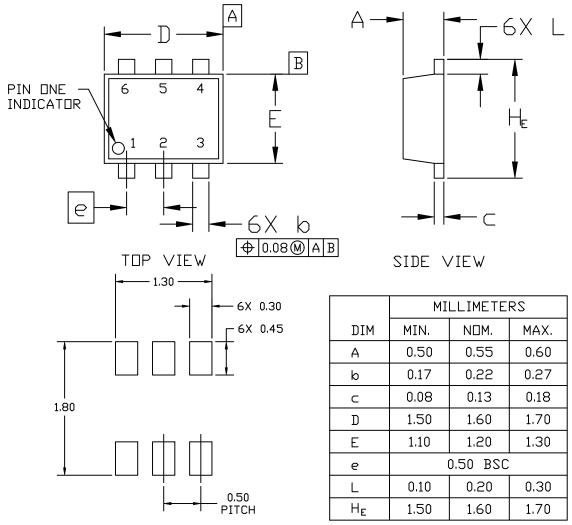
Figure 4. Capacitance

### PACKAGE DIMENSIONS

## SOT-563, 6 LEAD CASE 463A ISSUE H

### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.



### RECOMMENDED MOUNTING FOOTPRINT\*

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SILDERRM/D.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative